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December 2013

## ISL9R1560G2\_F085 15A, 600V Stealth Rectifier

#### **Features**

- High Speed Switching (t<sub>rr</sub>=26ns(Typ.) @ I<sub>F</sub>=15A)
- Low Forward Voltage( V<sub>F</sub>=2.2V(Max.) @ I<sub>F</sub>=15A )
- · Avalanche Energy Rated
- · AEC-Q101 Qualified

### **Applications**

- · Automotive DCDC converter
- · Automotive On Board Charger
- · Switching Power Supply
- · Power Switching Circuits

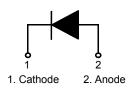
#### 15A, 600V Stealth Rectifier

The ISL9R1560G2\_F085 is Stealth<sup>TM</sup> diode optimized for low loss performance in high frequency hard switched applications. The Stealth<sup>TM</sup> family exhibits low reverse recovery current ( $I_{RM(REC)}$ ) and exceptionally soft recovery under typical operating conditions.

This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I<sub>RRM</sub> and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the Stealth™ diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

#### **Pin Assignments**





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V	
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V	
V <sub>R</sub>	DC Blocking Voltage	600	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 25°C	15	А	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current (Halfwave 1 Phase 50Hz)	45	А	
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ	
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 55 to +175	°C	

#### Thermal Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Max	Units	
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	0.93	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient 45		°C/W	

### **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Package	Tube	Quantity	
ISL9R1560G2		TO-247	-	30	

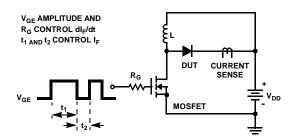
### **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

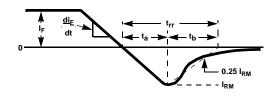
Symbol	Parameter	Conditions		Min.	Тур.	Max	Units
I <sub>R</sub>	Instantaneous Reverse Current	V <sub>R</sub> = 600V	T <sub>C</sub> = 25 °C	-	-	100	uA
			T <sub>C</sub> = 175 °C	-	-	2	mA
V <sub>FM</sub> <sup>1</sup>	Instantaneous Forward Voltage	I <sub>F</sub> = 15A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	1.8 1.35	2.2 2	V V
t <sub>rr</sub> <sup>2</sup>	Reverse Recovery Time	I <sub>F</sub> =1A, di/dt = 200A/μs, V <sub>CC</sub> = 390V	T <sub>C</sub> = 25 °C	-	20	30	ns
		$I_F$ =15A, di/dt = 200A/ $\mu$ s, $V_{CC}$ = 390V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	26 114	40 -	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	Reverse Recovery Time Reverse Recovery Charge	$I_F$ =15A, di/dt = 200A/ $\mu$ s, $V_{CC}$ = 390V	T <sub>C</sub> = 25 °C	- - -	15 11 40	- - -	ns ns nC
E <sub>AVL</sub>	Avalanche Energy	I <sub>AV</sub> =1A,L = 40mH		20	-	-	mJ

#### Notes:

- 1. Pulse : Test Pulse width =  $300\mu s$ , Duty Cycle = 2%
- 2. Guaranteed by design

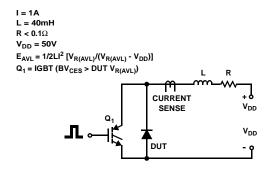
#### **Test Circuit and Waveforms**

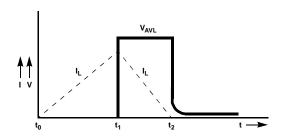




t<sub>rr</sub> Test Circuit

t<sub>rr</sub> Waveforms and Definitions



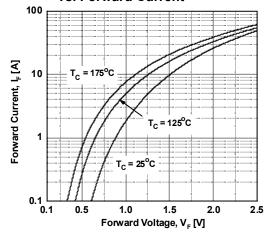


**Avalanche Energy Test Circuit** 

**Avalanche Current and Voltage Waveforms** 

### **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop vs. Forward Current



**Figure 3.Typical Junction Capacitance** 

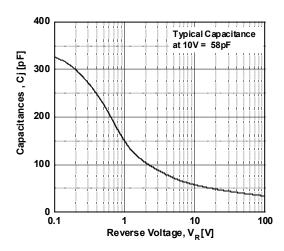


Figure 5. Typical Reverse Recovery Current vs. di/dt

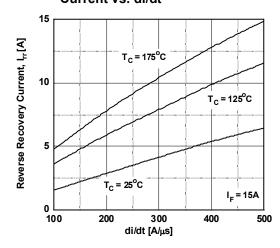


Figure 2. Typical Reverse Current vs.

Reverse Voltage

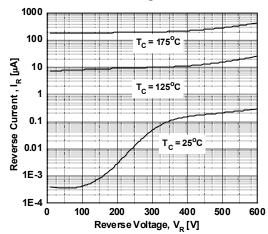


Figure 4. Typical Reverse Recovery Time vs. di/dt

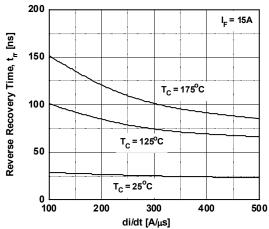
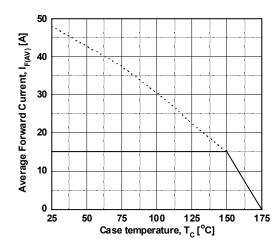


Figure 6. Forward Current Derating Curve



### **Typical Performance Characteristics** (Continued)

Figure 7. Reverse Recovery Charge

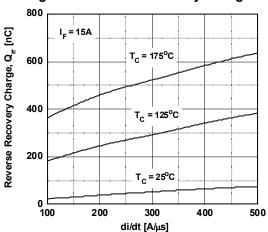
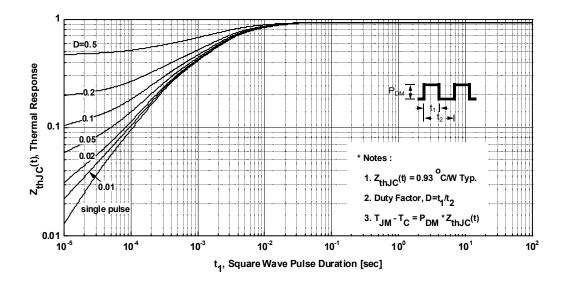
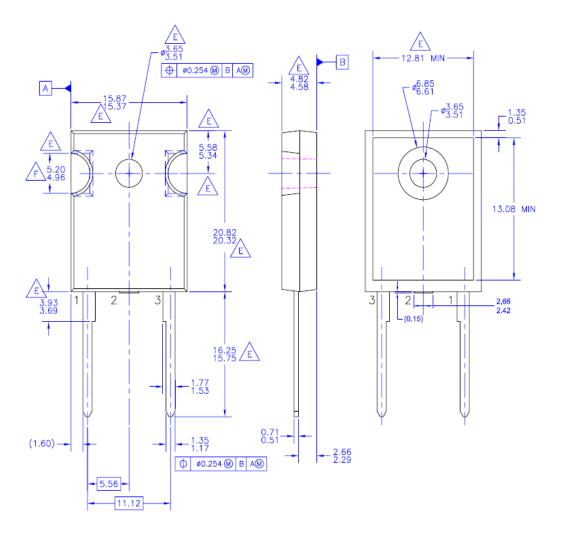


Figure 8. Transient Thermal Response Curve



#### **Mechanical Dimensions**

### TO-247-2L



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F. NOTCH MAY BE SQUARE

G. DRAWING FILENAME: MKT-TO247B02\_REV02

Dimensions in Millimeters





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